



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**PCN# 20150305000
Datasheet update for TPS53318/TPS53319
Information Only**

Date: 3/9/2015
To: MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services

**20150305000
Information Only
Attachments**

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TPS53318DQPR	null
TPS53318DQPT	null
TPS53319DQPT	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20150305000	PCN Date:	03/09/2015
Title:	Datasheet update for TPS53318/TPS53319		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

PCN Details

Description of Change:

Texas Instruments Incorporated is announcing an information-only product change notification.

The product datasheet(s) is being updated as summarized below.

The following change history provides further details:



www.ti.com

TPS53318, TPS53319

SLUSAY8D – JUNE 2012 – REVISED FEBRUARY 2015

Changes from Revision C (December 2014) to Revision D	Page
• Added recommendation for ROVP connection when ROVP function is not needed in <i>Pin Functions</i> table	3
• Corrected typographical error. Changed "when the VDD voltage rises above 1 V" to "when the VDD voltage rises above 2 V" in the <i>5-V LDO and VREG Start-Up</i> section.	14
• Added ROVP Pin Design Note in <i>Redundant Overvoltage Protection (OVP)</i> section.....	17

The datasheet number will be changing.

Device Family	Change From:	Change To:
TPS53318/TPS53319	SLUSAY8C	SLUSAY8D

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/tps53318>

Reason for Change:

To more accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Electrical specification performance changes as indicated above.

Changes to product identification resulting from this PCN:

None.

Product Affected:

TPS53318DQPR	TPS53318DQPT	TPS53319DQPR	TPS53319DQPT	
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com